F rm PTO-1449 (Rev. 2-97 by App.)

U.S. Department of Commerce Patent and Trademark Office

Att'y Docket No. Serial No.

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9911.1 Kelly 09/

Kevin W. Kelly et al

October 25, 2001 3743



## INFORMATION DISCLOSURE CITATION

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**CERTIFICATE** 

I hereby certify that this Information Disclosure Citation and copies of the three cited references are being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Box Non-Fee Amendment, Washington, D.C. 20231 on January 4, 2002.

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January 4, 2002

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